

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Islam et al. Date: January 21, 2010
Application No.: 10/561,381 Examiner: F.Y. Lopez
Filing Date: December 16, 2005 Group Art Unit: 2826
Title: LEAD FRAME ROUTED CHIP PADS FOR
SEMICONDUCTOR PACKAGES

Mail Stop Issue Fee
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT AFTER ALLOWANCE UNDER 37 C.F.R. § 1.312

Sir:

In response to the Notice of Allowance dated October 29, 2009, the Issue Fee being due on January 29, 2010 but not yet paid, and in accordance with the practice under 37 C.F.R. § 1.312, the Examiner is respectfully requested to amend the above-identified application as follows.

Amendments to the Claims begin on page 2 of this paper.

Remarks begin on page 5 of this paper.

CERTIFICATE OF MAILING OR TRANSMISSION (37 C.F.R. § 1.8(a))

I hereby certify that this correspondence (along with any paper referred to as being attached or enclosed) is being:

- ☐ deposited with the United States Postal Service on the date shown below with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.
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- ☒ transmitted via the electronic filing system of the United States Patent and Trademark Office on the date shown below and in accordance with 37 C.F.R. § 1.6(a)(4).

January 21, 2010

Signed: _____

Jay E. Anderson